Features

- Utilizes the AVR® RISC Architecture
- AVR High-performance and Low-power RISC Architecture
 - 120 Powerful Instructions Most Single Clock Cycle Execution
 - 32 x 8 General Purpose Working Registers
 - Fully Static Operation
 - Up to 20 MIPS Throughput at 20 MHz
- · Data and Non-volatile Program and Data Memories
 - 2K Bytes of In-System Self Programmable Flash Endurance 10,000 Write/Erase Cycles
 - 128 Bytes In-System Programmable EEPROM Endurance: 100,000 Write/Erase Cycles
 - 128 Bytes Internal SRAM
 - Programming Lock for Flash Program and EEPROM Data Security
- · Peripheral Features
 - One 8-bit Timer/Counter with Separate Prescaler and Compare Mode
 - One 16-bit Timer/Counter with Separate Prescaler, Compare and Capture Modes
 - Four PWM Channels
 - On-chip Analog Comparator
 - Programmable Watchdog Timer with On-chip Oscillator
 - USI Universal Serial Interface
 - Full Duplex USART
- Special Microcontroller Features
 - debugWIRE On-chip Debugging
 - In-System Programmable via SPI Port
 - External and Internal Interrupt Sources
 - Low-power Idle, Power-down, and Standby Modes
 - Enhanced Power-on Reset Circuit
 - Programmable Brown-out Detection Circuit
 - Internal Calibrated Oscillator
- I/O and Packages
 - 18 Programmable I/O Lines
 - 20-pin PDIP, 20-pin SOIC, 20-pad QFN/MLF
- Operating Voltages
 - 1.8 5.5V (ATtiny2313V)
 - 2.7 5.5V (ATtiny2313)
- Speed Grades
 - ATtiny2313V: 0 4 MHz @ 1.8 5.5V, 0 10 MHz @ 2.7 5.5V
 - ATtiny2313: 0 10 MHz @ 2.7 5.5V, 0 20 MHz @ 4.5 5.5V
- Typical Power Consumption
 - Active Mode
 - 1 MHz, 1.8V: 230 µA
 - 32 kHz, 1.8V: 20 µA (including oscillator)
 - Power-down Mode
 - < 0.1 µA at 1.8V



8-bit **AVR**®
Microcontroller with 2K Bytes
In-System
Programmable
Flash

ATtiny2313/V

Preliminary

Summary

Not recommended for new designs. Use:

- ATtiny2313A



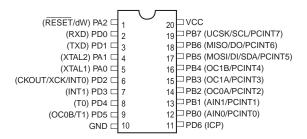
Rev. 2543KS-AVR-03/10

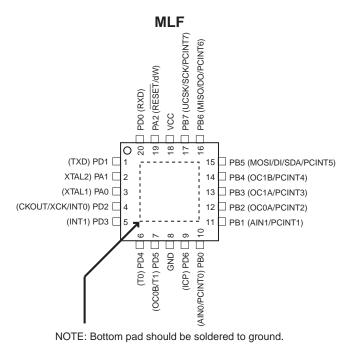


Pin Configurations

Figure 1. Pinout ATtiny2313

PDIP/SOIC



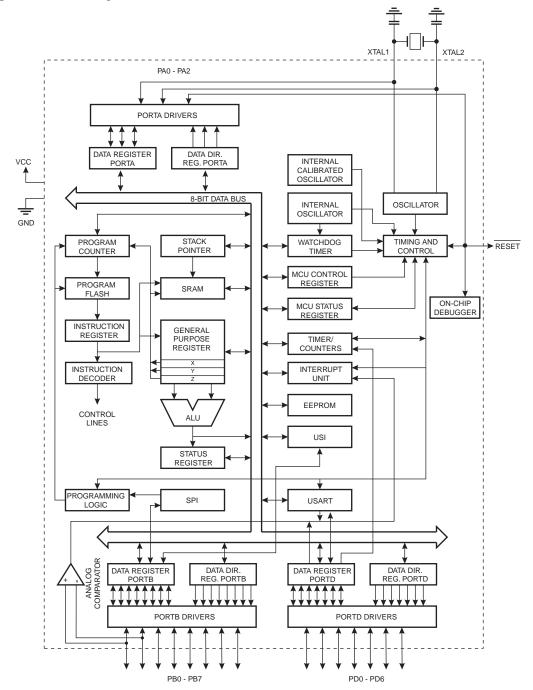


Overview

The ATtiny2313 is a low-power CMOS 8-bit microcontroller based on the AVR enhanced RISC architecture. By executing powerful instructions in a single clock cycle, the ATtiny2313 achieves throughputs approaching 1 MIPS per MHz allowing the system designer to optimize power consumption versus processing speed.

Block Diagram

Figure 2. Block Diagram







The AVR core combines a rich instruction set with 32 general purpose working registers. All the 32 registers are directly connected to the Arithmetic Logic Unit (ALU), allowing two independent registers to be accessed in one single instruction executed in one clock cycle. The resulting architecture is more code efficient while achieving throughputs up to ten times faster than conventional CISC microcontrollers.

The ATtiny2313 provides the following features: 2K bytes of In-System Programmable Flash, 128 bytes EEPROM, 128 bytes SRAM, 18 general purpose I/O lines, 32 general purpose working registers, a single-wire Interface for On-chip Debugging, two flexible Timer/Counters with compare modes, internal and external interrupts, a serial programmable USART, Universal Serial Interface with Start Condition Detector, a programmable Watchdog Timer with internal Oscillator, and three software selectable power saving modes. The Idle mode stops the CPU while allowing the SRAM, Timer/Counters, and interrupt system to continue functioning. The Power-down mode saves the register contents but freezes the Oscillator, disabling all other chip functions until the next interrupt or hardware reset. In Standby mode, the crystal/resonator Oscillator is running while the rest of the device is sleeping. This allows very fast start-up combined with low-power consumption.

The device is manufactured using Atmel's high density non-volatile memory technology. The On-chip ISP Flash allows the program memory to be reprogrammed In-System through an SPI serial interface, or by a conventional non-volatile memory programmer. By combining an 8-bit RISC CPU with In-System Self-Programmable Flash on a monolithic chip, the Atmel ATtiny2313 is a powerful microcontroller that provides a highly flexible and cost effective solution to many embedded control applications.

The ATtiny2313 AVR is supported with a full suite of program and system development tools including: C Compilers, Macro Assemblers, Program Debugger/Simulators, In-Circuit Emulators, and Evaluation kits.

Pin Descriptions

VCC Digital supply voltage.

GND Ground.

Port A (PA2..PA0)

Port A is a 3-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The Port A output buffers have symmetrical drive characteristics with both high sink and source

capability. As inputs, Port A pins that are externally pulled low will source current if the pull-up resistors are activated. The Port A pins are tri-stated when a reset condition becomes active,

even if the clock is not running.

Port A also serves the functions of various special features of the ATtiny2313 as listed on page

55.

Port B (PB7..PB0) Port B is an 8-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The Port B output buffers have symmetrical drive characteristics with both high sink and source

capability. As inputs, Port B pins that are externally pulled low will source current if the pull-up resistors are activated. The Port B pins are tri-stated when a reset condition becomes active.

even if the clock is not running.

Port B also serves the functions of various special features of the ATtiny2313 as listed on page

55.

Port D (PD6..PD0) Port D is a 7-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The

Port D output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port D pins that are externally pulled low will source current if the pull-up resistors are activated. The Port D pins are tri-stated when a reset condition becomes active,

even if the clock is not running.

Port D also serves the functions of various special features of the ATtiny2313 as listed on page

58.

RESET Reset input. A low level on this pin for longer than the minimum pulse length will generate a

reset, even if the clock is not running. The minimum pulse length is given in Table 15 on page 36. Shorter pulses are not guaranteed to generate a reset. The Reset Input is an alternate func-

tion for PA2 and dW.

XTAL1 Input to the inverting Oscillator amplifier and input to the internal clock operating circuit. XTAL1

is an alternate function for PA0.

XTAL2 Output from the inverting Oscillator amplifier. XTAL2 is an alternate function for PA1.





Resources

A comprehensive set of development tools, application notes and datasheets are available for downloadon http://www.atmel.com/avr.

About Code Examples

This documentation contains simple code examples that briefly show how to use various parts of the device. These code examples assume that the part specific header file is included before compilation. Be aware that not all C compiler vendors include bit definitions in the header files and interrupt handling in C is compiler dependent. Please confirm with the C compiler documentation for more details.





Disclaimer

Typical values contained in this data sheet are based on simulations and characterization of other AVR microcontrollers manufactured on the same process technology. Min and Max values will be available after the device is characterized.

Register Summary

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Page
			T							
0x3F (0x5F) 0x3E (0x5E)	SREG Reserved		_	H -	S -	V	N -	Z	C -	10
0x3D (0x5D)	SPL	SP7	SP6	SP5	SP4	SP3	SP2	SP1	SP0	13
0x3C (0x5C)	OCR0B	G	0.0		Fimer/Counter0 –			0	0.0	79
0x3B (0x5B)	GIMSK	INT1	INT0	PCIE	-	-	-	_	_	62
0x3A (0x5A)	EIFR	INTF1	INTF0	PCIF	-	_	-	_	_	63
0x39 (0x59)	TIMSK	TOIE1	OCIE1A	OCIE1B	-	ICIE1	OCIE0B	TOIE0	OCIE0A	80, 111
0x38 (0x58)	TIFR	TOV1	OCF1A	OCF1B	_	ICF1	OCF0B	TOV0	OCF0A	80
0x37 (0x57)	SPMCSR	-	-	-	СТРВ	RFLB	PGWRT	PGERS	SELFPRGEN	157
0x36 (0x56)	OCR0A		1	,	Timer/Counter0 –	Compare Registe	er A	1	1	79
0x35 (0x55)	MCUCR	PUD	SM1	SE	SM0	ISC11	ISC10	ISC01	ISC00	55
0x34 (0x54)	MCUSR	_	-	-	-	WDRF	BORF	EXTRF	PORF	39
0x33 (0x53)	TCCR0B	FOC0A	FOC0B	-		WGM02	CS02	CS01	CS00	78
0x32 (0x52)	TCNT0 OSCCAL	_	CALC	CALE	CAL4	unter0 (8-bit) CAL3	CALO	CAL1	CAL0	79 28
0x31 (0x51) 0x30 (0x50)	TCCR0A	COM0A1	CAL6 COM0A0	CAL5 COM0B1	CAL4 COM0B0	- CALS	CAL2	WGM01	WGM00	75
0x36 (0x36) 0x2F (0x4F)	TCCR1A	COMIDAT COM1A1	COMIA0	COM1B1	COM1BO			WGM11	WGM10	106
0x2E (0x4E)	TCCR1B	ICNC1	ICES1	-	WGM13	WGM12	CS12	CS11	CS10	109
0x2D (0x4D)	TCNT1H				er/Counter1 – Co					110
0x2C (0x4C)	TCNT1L				er/Counter1 – Co		•			110
0x2B (0x4B)	OCR1AH				/Counter1 – Com					110
0x2A (0x4A)	OCR1AL			Timer	/Counter1 – Com	pare Register A L	ow Byte			110
0x29 (0x49)	OCR1BH			Timer	/Counter1 – Com	pare Register B F	ligh Byte			111
0x28 (0x48)	OCR1BL			Timer	/Counter1 – Com	pare Register B L	ow Byte			111
0x27 (0x47)	Reserved	-	-	-	-	-	-	-	-	
0x26 (0x46)	CLKPR	CLKPCE	-	-	-	CLKPS3	CLKPS2	CLKPS1	CLKPS0	30
0x25 (0x45)	ICR1H				Counter1 - Input (111
0x24 (0x44)	ICR1L			Timer/	Counter1 - Input (Capture Register	Low Byte		DODAG	111
0x23 (0x43)	GTCCR	- FOC1A	- F004B	-	-	_	-	-	PSR10	83
0x22 (0x42) 0x21 (0x41)	TCCR1C WDTCSR	FOC1A WDIF	FOC1B WDIE	WDP3	- WDCE	- WDE	WDP2	WDP1	- WDP0	110 44
0x21 (0x41) 0x20 (0x40)	PCMSK	PCINT7	PCINT6	PCINT5	PCINT4	PCINT3	PCINT2	PCINT1	PCINT0	63
0x1F (0x3F)	Reserved	-	-	-	-	-	-	-	-	- 00
0x1E (0x3E)	EEAR	_			EEP	ROM Address Re	egister			18
0x1D (0x3D)	EEDR		•			Data Register				19
0x1C (0x3C)	EECR	-	-	EEPM1	EEPM0	EERIE	EEMPE	EEPE	EERE	19
0x1B (0x3B)	PORTA	-	-	-	_	-	PORTA2	PORTA1	PORTA0	60
0x1A (0x3A)	DDRA	_	-	-	-	-	DDA2	DDA1	DDA0	60
0x19 (0x39)	PINA	ı	-	-	-	-	PINA2	PINA1	PINA0	60
0x18 (0x38)	PORTB	PORTB7	PORTB6	PORTB5	PORTB4	PORTB3	PORTB2	PORTB1	PORTB0	60
0x17 (0x37)	DDRB	DDB7	DDB6	DDB5	DDB4	DDB3	DDB2	DDB1	DDB0	60
0x16 (0x36)	PINB	PINB7	PINB6	PINB5	PINB4	PINB3	PINB2	PINB1	PINB0	60
0x15 (0x35) 0x14 (0x34)	GPIOR2 GPIOR1					se I/O Register 2 se I/O Register 1				23 23
0x14 (0x34) 0x13 (0x33)	GPIOR1					se I/O Register 0				23
0x13 (0x33) 0x12 (0x32)	PORTD	-	PORTD6	PORTD5	PORTD4	PORTD3	PORTD2	PORTD1	PORTD0	60
0x12 (0x32) 0x11 (0x31)	DDRD		DDD6	DDD5	DDD4	DDD3	DDD2	DDD1	DDD0	60
0x10 (0x30)	PIND	-	PIND6	PIND5	PIND4	PIND3	PIND2	PIND1	PIND0	60
0x0F (0x2F)	USIDR					a Register			·	146
0x0E (0x2E)	USISR	USISIF	USIOIF	USIPF	USIDC	USICNT3	USICNT2	USICNT1	USICNT0	147
0x0D (0x2D)	USICR	USISIE	USIOIE	USIWM1	USIWM0	USICS1	USICS0	USICLK	USITC	147
0x0C (0x2C)	UDR		1		UART Data	Register (8-bit)				131
0x0B (0x2B)	UCSRA	RXC	TXC	UDRE	FE	DOR	UPE	U2X	MPCM	131
0x0A (0x2A)	UCSRB	RXCIE	TXCIE	UDRIE	RXEN	TXEN	UCSZ2	RXB8	TXB8	133
0x09 (0x29)	UBRRL	107	1070	465		RH[7:0]	4.0:0	1	10:22	135
0x08 (0x28)	ACSR	ACD	ACBG	ACO	ACI	ACIE	ACIC	ACIS1	ACIS0	151
0x07 (0x27)	Reserved	-	-	-	-	-	-	-	_	
0x06 (0x26) 0x05 (0x25)	Reserved	_	-	_	-	_	-	_	_	
0x05 (0x25)	Reserved Reserved	_	_	_	_	_	_	_	-	
	i todol vou		UMSEL	UPM1	UPM0	USBS	UCSZ1	UCSZ0	UCPOL	134
	UCSRC	_				0000	00021	00020	JOI OL	- 77
0x03 (0x23)	UCSRC UBRRH	-	-	-	_		UBRF	RH[11:8]		135
	UCSRC UBRRH DIDR		1			-	UBRF -	RH[11:8] AIN1D	AIN0D	135 152





Note:

- 1. For compatibility with future devices, reserved bits should be written to zero if accessed. Reserved I/O memory addresses should never be written.
- 2. I/O Registers within the address range 0x00 0x1F are directly bit-accessible using the SBI and CBI instructions. In these registers, the value of single bits can be checked by using the SBIS and SBIC instructions.
- 3. Some of the status flags are cleared by writing a logical one to them. Note that, unlike most other AVRs, the CBI and SBI instructions will only operate on the specified bit, and can therefore be used on registers containing such status flags. The CBI and SBI instructions work with registers 0x00 to 0x1F only.
- 4. When using the I/O specific commands IN and OUT, the I/O addresses 0x00 0x3F must be used. When addressing I/O Registers as data space using LD and ST instructions, 0x20 must be added to these addresses.

Instruction Set Summary

Mnemonics	Operands	Description	Operation	Flags	#Clocks
ARITHMETIC AND L	OGIC INSTRUCTIONS	6		•	
ADD	Rd, Rr	Add two Registers	$Rd \leftarrow Rd + Rr$	Z,C,N,V,H	1
ADC	Rd, Rr	Add with Carry two Registers	$Rd \leftarrow Rd + Rr + C$	Z,C,N,V,H	1
ADIW	RdI,K	Add Immediate to Word	$Rdh:RdI \leftarrow Rdh:RdI + K$	Z,C,N,V,S	2
SUB	Rd, Rr	Subtract two Registers	$Rd \leftarrow Rd - Rr$	Z,C,N,V,H	1
SUBI	Rd, K	Subtract Constant from Register	$Rd \leftarrow Rd - K$	Z,C,N,V,H	1
SBC	Rd, Rr	Subtract with Carry two Registers	$Rd \leftarrow Rd - Rr - C$	Z,C,N,V,H	1
SBCI	Rd, K	Subtract with Carry Constant from Reg.	$Rd \leftarrow Rd - K - C$	Z,C,N,V,H	1
SBIW	Rdl,K	Subtract Immediate from Word	Rdh:Rdl ← Rdh:Rdl - K	Z,C,N,V,S	2
AND	Rd, Rr	Logical AND Registers	$Rd \leftarrow Rd \bullet Rr$	Z,N,V	1
ANDI	Rd, K	Logical AND Register and Constant	Rd ← Rd • K	Z,N,V	1
OR	Rd, Rr	Logical OR Registers	Rd ← Rd v Rr	Z,N,V	1
ORI	Rd, K	Logical OR Register and Constant	Rd ← Rd v K	Z,N,V	1
EOR	Rd, Rr	Exclusive OR Registers	Rd ← Rd ⊕ Rr	Z,N,V	1
COM	Rd	One's Complement	$Rd \leftarrow 0xFF - Rd$	Z,C,N,V	1
NEG	Rd	Two's Complement	Rd ← 0x00 – Rd	Z,C,N,V,H	1
SBR	Rd,K	Set Bit(s) in Register	Rd ← Rd v K	Z,N,V	1
CBR	Rd,K	Clear Bit(s) in Register	$Rd \leftarrow Rd \bullet (0xFF - K)$	Z,N,V	1
INC DEC	Rd Rd	Increment	$Rd \leftarrow Rd + 1$ $Rd \leftarrow Rd - 1$	Z,N,V Z,N,V	1
TST	Rd	Decrement Test for Zero or Minus	Rd ← Rd − 1 Rd ← Rd • Rd	Z,N,V Z,N,V	1
CLR	Rd				1
SER	Rd	Clear Register Set Register	$Rd \leftarrow Rd \oplus Rd$ $Rd \leftarrow 0xFF$	Z,N,V None	1
BRANCH INSTRUCT		Set Register	Rd ← UXFF	None	
RJMP	k	Relative Jump	PC ← PC + k + 1	None	2
IJMP	N.	Indirect Jump to (Z)	PC ← Z	None	2
RCALL	k	Relative Subroutine Call	PC ← PC + k + 1	None	3
ICALL	K	Indirect Call to (Z)	PC ← Z	None	3
RET		Subroutine Return	PC ← STACK	None	4
RETI		Interrupt Return	PC ← STACK	I	4
CPSE	Rd,Rr	Compare, Skip if Equal	if (Rd = Rr) PC ← PC + 2 or 3	None	1/2/3
CP	Rd,Rr	Compare	Rd – Rr	Z, N,V,C,H	1
CPC	Rd,Rr	Compare with Carry	Rd – Rr – C	Z, N,V,C,H	1
CPI	Rd,K	Compare Register with Immediate	Rd – K	Z, N,V,C,H	1
SBRC	Rr, b	Skip if Bit in Register Cleared	if (Rr(b)=0) PC ← PC + 2 or 3	None	1/2/3
SBRS	Rr, b	Skip if Bit in Register is Set	if (Rr(b)=1) PC ← PC + 2 or 3	None	1/2/3
SBIC	P, b	Skip if Bit in I/O Register Cleared	if (P(b)=0) PC ← PC + 2 or 3	None	1/2/3
SBIS	P, b	Skip if Bit in I/O Register is Set	if (P(b)=1) PC ← PC + 2 or 3	None	1/2/3
BRBS	s, k	Branch if Status Flag Set	if (SREG(s) = 1) then PC←PC+k + 1	None	1/2
BRBC	s, k	Branch if Status Flag Cleared	if (SREG(s) = 0) then PC←PC+k + 1	None	1/2
BREQ	k	Branch if Equal	if (Z = 1) then PC ← PC + k + 1	None	1/2
BRNE	k	Branch if Not Equal	if (Z = 0) then PC ← PC + k + 1	None	1/2
BRCS	k	Branch if Carry Set	if (C = 1) then PC ← PC + k + 1	None	1/2
BRCC	k	Branch if Carry Cleared	if (C = 0) then PC ← PC + k + 1	None	1/2
BRSH	k	Branch if Same or Higher	if (C = 0) then PC ← PC + k + 1	None	1/2
BRLO	k	Branch if Lower	if (C = 1) then PC ← PC + k + 1	None	1/2
BRMI	k	Branch if Minus	if (N = 1) then PC ← PC + k + 1	None	1/2
BRPL	k	Branch if Plus	if (N = 0) then PC \leftarrow PC + k + 1	None	1/2
BRGE	k	Branch if Greater or Equal, Signed	if (N \oplus V= 0) then PC \leftarrow PC + k + 1	None	1/2
BRLT	k	Branch if Less Than Zero, Signed	if (N \oplus V= 1) then PC \leftarrow PC + k + 1	None	1/2
BRHS	k	Branch if Half Carry Flag Set	if (H = 1) then PC ← PC + k + 1	None	1/2
BRHC	k	Branch if Half Carry Flag Cleared	if (H = 0) then PC ← PC + k + 1	None	1/2
BRTS	k	Branch if T Flag Set	if (T = 1) then PC ← PC + k + 1	None	1/2
BRTC	k	Branch if T Flag Cleared	if (T = 0) then PC ← PC + k + 1	None	1/2
BRVS	k	Branch if Overflow Flag is Set	if (V = 1) then PC ← PC + k + 1	None	1/2
BRVC	k	Branch if Overflow Flag is Cleared	if (V = 0) then PC \leftarrow PC + k + 1	None	1/2
BRIE	k	Branch if Interrupt Enabled	if (I = 1) then PC ← PC + k + 1	None	1/2
BRID	k	Branch if Interrupt Disabled	if (I = 0) then PC ← PC + k + 1	None	1/2
BIT AND BIT-TEST I			1	T	T
SBI	P,b	Set Bit in I/O Register	I/O(P,b) ← 1	None	2
CBI	P,b	Clear Bit in I/O Register	I/O(P,b) ← 0	None	2
LSL	Rd	Logical Shift Left	$Rd(n+1) \leftarrow Rd(n), Rd(0) \leftarrow 0$	Z,C,N,V	1
LSR	Rd	Logical Shift Right	$Rd(n) \leftarrow Rd(n+1), Rd(7) \leftarrow 0$	Z,C,N,V	1
ROL	Rd	Rotate Left Through Carry	$Rd(0)\leftarrow C,Rd(n+1)\leftarrow Rd(n),C\leftarrow Rd(7)$	Z,C,N,V	1





Mnemonics	Operands	Description	Operation	Flags	#Clocks
ROR	Rd	Rotate Right Through Carry	$Rd(7)\leftarrow C,Rd(n)\leftarrow Rd(n+1),C\leftarrow Rd(0)$	Z,C,N,V	1
ASR	Rd	Arithmetic Shift Right	Rd(n) ← Rd(n+1), n=06	Z,C,N,V	1
SWAP	Rd	Swap Nibbles	Rd(30)←Rd(74),Rd(74)←Rd(30)	None	1
BSET	s	Flag Set	SREG(s) ← 1	SREG(s)	1
BCLR	s	Flag Clear	SREG(s) ← 0	SREG(s)	1
BST	Rr, b	Bit Store from Register to T	$T \leftarrow Rr(b)$	T	1
BLD	Rd, b	Bit load from T to Register	Rd(b) ← T	None	1
SEC	110, 2	Set Carry	C ← 1	C	1
CLC		Clear Carry	C ← 0	C	1
SEN		Set Negative Flag	N ← 1	N	1
CLN		Clear Negative Flag	N ← 0	N	1
SEZ		Set Zero Flag	Z ← 1	Z	1
CLZ		Clear Zero Flag	Z ← 0	Z	1
SEI		Global Interrupt Enable		1	1
		·	I ← 1		1
CLI		Global Interrupt Disable	1←0	1	
SES	+	Set Signed Test Flag	S ← 1	S	1
CLS		Clear Signed Test Flag	S ← 0	S	1
SEV		Set Twos Complement Overflow.	V ← 1	V	1
CLV		Clear Twos Complement Overflow	V ← 0	V	1
SET		Set T in SREG	T ← 1	T	1
CLT	-	Clear T in SREG	T ← 0	Т	1
SEH		Set Half Carry Flag in SREG	H ← 1	Н	1
CLH		Clear Half Carry Flag in SREG	H ← 0	Н	1
DATA TRANSFER I	INSTRUCTIONS				
MOV	Rd, Rr	Move Between Registers	Rd ← Rr	None	1
MOVW	Rd, Rr	Copy Register Word	$Rd+1:Rd \leftarrow Rr+1:Rr$	None	1
LDI	Rd, K	Load Immediate	$Rd \leftarrow K$	None	1
LD	Rd, X	Load Indirect	$Rd \leftarrow (X)$	None	2
LD	Rd, X+	Load Indirect and Post-Inc.	$Rd \leftarrow (X), X \leftarrow X + 1$	None	2
LD	Rd, - X	Load Indirect and Pre-Dec.	$X \leftarrow X - 1$, $Rd \leftarrow (X)$	None	2
LD	Rd, Y	Load Indirect	$Rd \leftarrow (Y)$	None	2
LD	Rd, Y+	Load Indirect and Post-Inc.	$Rd \leftarrow (Y), Y \leftarrow Y + 1$	None	2
LD	Rd, - Y	Load Indirect and Pre-Dec.	$Y \leftarrow Y - 1$, $Rd \leftarrow (Y)$	None	2
LDD	Rd,Y+q	Load Indirect with Displacement	$Rd \leftarrow (Y + q)$	None	2
LD	Rd, Z	Load Indirect	Rd ← (Z)	None	2
LD	Rd, Z+	Load Indirect and Post-Inc.	$Rd \leftarrow (Z), Z \leftarrow Z+1$	None	2
LD	Rd, -Z	Load Indirect and Pre-Dec.	$Z \leftarrow Z - 1$, $Rd \leftarrow (Z)$	None	2
LDD	Rd, Z+q	Load Indirect with Displacement	$Rd \leftarrow (Z + q)$	None	2
LDS	Rd, k	Load Direct from SRAM	Rd ← (k)	None	2
ST	X, Rr	Store Indirect	(X) ← Rr	None	2
ST	X+, Rr	Store Indirect and Post-Inc.	$(X) \leftarrow Rr, X \leftarrow X + 1$	None	2
ST	- X, Rr	Store Indirect and Pre-Dec.	$X \leftarrow X - 1, (X) \leftarrow Rr$	None	2
ST	Y, Rr	Store Indirect	(Y) ← Rr	None	2
ST	Y+, Rr	Store Indirect and Post-Inc.	$(Y) \leftarrow Rr, Y \leftarrow Y + 1$	None	2
ST	- Y, Rr	Store Indirect and Pre-Dec.	$Y \leftarrow Y - 1, (Y) \leftarrow Rr$	None	2
STD	Y+q,Rr	Store Indirect with Displacement	(Y + q) ← Rr	None	2
ST	Z, Rr	Store Indirect	(Z) ← Rr	None	2
ST	Z+, Rr	Store Indirect and Post-Inc.	$(Z) \leftarrow R$ $(Z) \leftarrow R$ $(Z) \leftarrow Z + 1$	None	2
ST	-Z, Rr	Store Indirect and Pre-Dec.	$Z \leftarrow Z - 1, (Z) \leftarrow Rr$	None	2
STD	Z+q,Rr	Store Indirect with Displacement	$(Z+q) \leftarrow Rr$		2
STS	k, Rr	Store Direct to SRAM	$(k) \leftarrow Rr$	None None	2
LPM	rs, rsi	Load Program Memory	$(K) \leftarrow KI$ $R0 \leftarrow (Z)$	None	3
	Pd 7	,	` '		3
LPM	Rd, Z	Load Program Memory and Post Inc.	Rd ← (Z)	None	
LPM	Rd, Z+	Load Program Memory and Post-Inc	$Rd \leftarrow (Z), Z \leftarrow Z+1$	None	3
SPM	D4 D	Store Program Memory	(Z) ← R1:R0	None	- 1
IN	Rd, P	In Port	Rd ← P	None	1
OUT	P, Rr	Out Port	P ← Rr	None	1
PUSH	Rr	Push Register on Stack	STACK ← Rr	None	2
POP	Rd	Pop Register from Stack	$Rd \leftarrow STACK$	None	2
MCU CONTROL IN	STRUCTIONS				
NOP		No Operation		None	1
SLEEP		Sleep	(see specific descr. for Sleep function)	None	1
WDR		Watchdog Reset	(see specific descr. for WDR/timer)	None	1
BREAK		Break	For On-chip Debug Only	None	N/A

Ordering Information

Speed (MHz) ⁽³⁾	Power Supply	Ordering Code	Package ⁽¹⁾	Operation Range
10	1.8 - 5.5V	ATtiny2313V-10PI ATtiny2313V-10PU ⁽²⁾ ATtiny2313V-10SI ATtiny2313V-10SU ⁽²⁾ ATtiny2313V-10MU ⁽²⁾	20P3 20P3 20S 20S 20M1	Industrial (-40°C to 85°C)
20	2.7 - 5.5V	ATtiny2313-20PI ATtiny2313-20PU ⁽²⁾ ATtiny2313-20SI ATtiny2313-20SU ⁽²⁾ ATtiny2313-20MU ⁽²⁾	20P3 20P3 20S 20S 20M1	Industrial (-40°C to 85°C)

Note:

- 1. This device can also be supplied in wafer form. Please contact your local Atmel sales office for detailed ordering information and minimum quantities.
- 2. Pb-free packaging alternative, complies to the European Directive for Restriction of Hazardous Substances (RoHS directive). Also Halide free and fully Green.
- 3. For Speed vs. V_{CC_i} see Figure 82 on page 182 and Figure 83 on page 182.

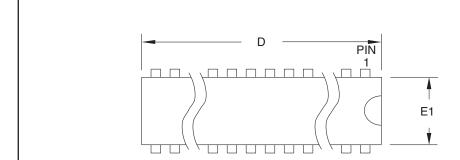
Package Type					
20P3	20P3 20-lead, 0.300" Wide, Plastic Dual Inline Package (PDIP)				
20S 20-lead, 0.300" Wide, Plastic Gull Wing Small Outline Package (SOIC)					
20M1 20-pad, 4 x 4 x 0.8 mm Body, Quad Flat No-Lead/Micro Lead Frame Package (MLF)					

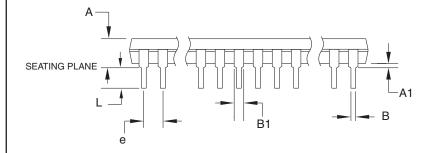


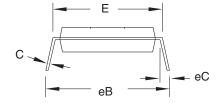


Packaging Information

20P3







Notes:

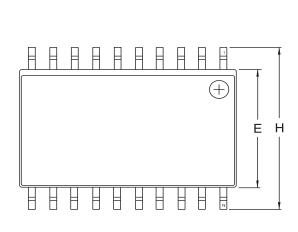
- 1. This package conforms to JEDEC reference MS-001, Variation AD.
- Dimensions D and E1 do not include mold Flash or Protrusion. Mold Flash or Protrusion shall not exceed 0.25 mm (0.010").

COMMON DIMENSIONS (Unit of Measure = mm)

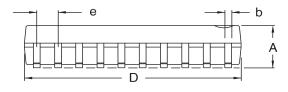
SYMBOL MIN NOM MAX NOTE Α 5.334 Α1 0.381 25.493 D 25.984 Note 2 Е 7.620 8.255 _ 6.096 7.112 Note 2 В 0.356 0.559 B1 1.270 1.551 2.921 3.810 С 0.203 0.356 10.922 eС 0.000 1.524 2.540 TYP

1/12/04

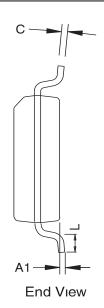
			TITLE	DRAWING NO.	REV.
4	AIMEL	2325 Orchard Parkway San Jose, CA 95131	20P3 , 20-lead (0.300"/7.62 mm Wide) Plastic Dual Inline Package (PDIP)	20P3	С







Side View



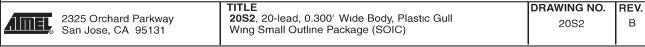
COMMON DIMENSIONS

(Unit of Measure - mm)

SYMBOL	MIN	NOM	MAX	NOTE
Α	2.35		2.65	
A1	0.10		0.30	
b	0.33		0.51	4
С	0.23		0.32	
D	12.60		13.00	1
Е	7.40		7.60	2
Н	10.00		10.65	
L	0.40		1.27	3
е		1.27 BS		

- Notes.
 This drawing is for general information only; refer to JEDEC Drawing MS-013, Variation AC for additional information.
 Dimension 'D' does not include mold Flash, protrusions or gate burrs. Mold Flash, protrusions and gate burrs shall not exceed 0.15 mm (0.006') per side.
 Dimension 'E' does not include inter-lead Flash or protrusion. Inter-lead Flash and protrusions shall not exceed 0.25 mm

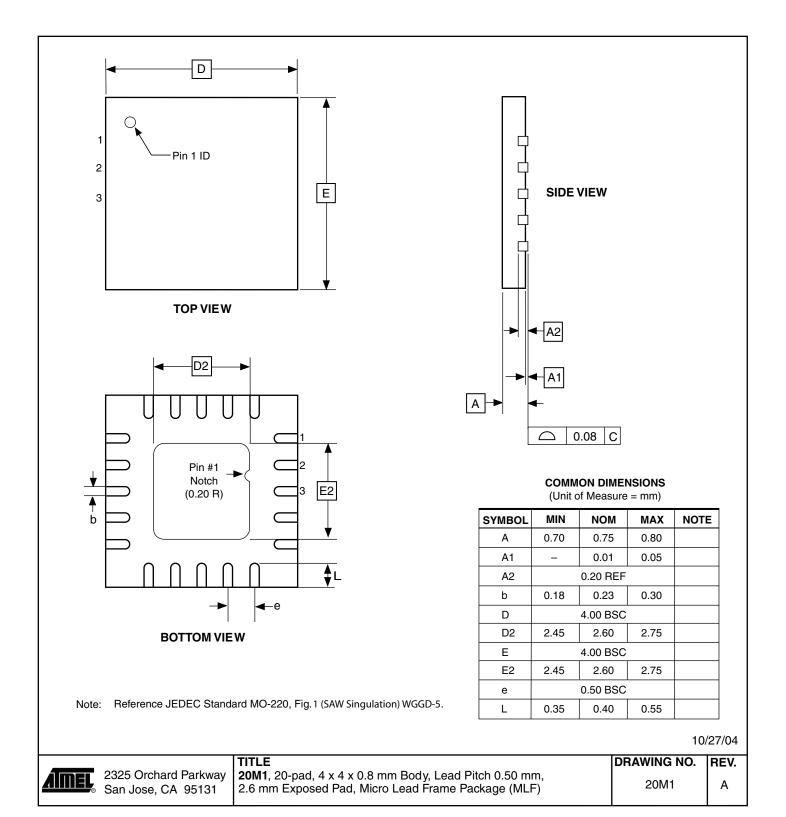
 - 3. Dimension E does not include interriead hash of profusion. Interriead hash of profusion. Interriead hash of (0.010) per side.
 4. 'L' is the length of the terminal for soldering to a substrate.
 5. The lead width 'b', as measured 0.36 mm (0.014') or greater above the seating plane, shall not exceed a maximum value of 0.61 mm 11/6/06 (0.024') per side.







20M1



Errata

The revision in this section refers to the revision of the ATtiny2313 device.

ATtiny2313 Rev C No known errata

ATtiny2313 Rev B

- · Wrong values read after Erase Only operation
- Parallel Programming does not work
- · Watchdog Timer Interrupt disabled
- EEPROM can not be written below 1.9 volts

1. Wrong values read after Erase Only operation

At supply voltages below 2.7 V, an EEPROM location that is erased by the Erase Only operation may read as programmed (0x00).

Problem Fix/Workaround

If it is necessary to read an EEPROM location after Erase Only, use an Atomic Write operation with 0xFF as data in order to erase a location. In any case, the Write Only operation can be used as intended. Thus no special considerations are needed as long as the erased location is not read before it is programmed.

2. Parallel Programming does not work

Parallel Programming is not functioning correctly. Because of this, reprogramming of the device is impossible if one of the following modes are selected:

- In-System Programming disabled (SPIEN unprogrammed)
- Reset Disabled (RSTDISBL programmed)

Problem Fix/Workaround

Serial Programming is still working correctly. By avoiding the two modes above, the device can be reprogrammed serially.

3. Watchdog Timer Interrupt disabled

If the watchdog timer interrupt flag is not cleared before a new timeout occurs, the watchdog will be disabled, and the interrupt flag will automatically be cleared. This is only applicable in interrupt only mode. If the Watchdog is configured to reset the device in the watchdog timeout following an interrupt, the device works correctly.

Problem fix / Workaround

Make sure there is enough time to always service the first timeout event before a new watchdog timeout occurs. This is done by selecting a long enough time-out period.

4. EEPROM can not be written below 1.9 volts

Writing the EEPROM at V_{CC} below 1.9 volts might fail.

Problem fix / Workaround

Do not write the EEPROM when V_{CC} is below 1.9 volts.

ATtiny2313 Rev A Revision A has not been sampled.





Datasheet Revision History

Please note that the referring page numbers in this section are referred to this document. The referring revision in this section are referring to the document revision.

Rev. K - 03/10

1. Added device Rev C "No known errata" in "Errata" on page 17.

Rev. J - 11/09

- 1. Updated template
- 2. Changed device status to "Not recommended for new designs."
- 3. Updated "Stack Pointer" on page 13.
- 4. Updated Table "Sleep Mode Select" on page 32.
- 5. Updated "Calibration Byte" on page 162 (to one byte of calibration data)

Changes from Rev. 2514H-02/05 to Rev. 2514I-04/06

- 1. Updated typos.
- 2. Updated Figure 1 on page 2.
- 3 Added "Resources" on page 6.
- 4. Updated "Default Clock Source" on page 25.
- 5. Updated "128 kHz Internal Oscillator" on page 30.
- 6. Updated "Power Management and Sleep Modes" on page 32
- 7. Updated Table 3 on page 25, Table 13 on page 32, Table 14 on page 33, Table 19 on page 44, Table 31 on page 62, Table 79 on page 178.
- 8. Updated "External Interrupts" on page 61.
- 9. Updated "Bit 7..0 PCINT7..0: Pin Change Enable Mask 7..0" on page 63.
- 10. Updated "Bit 6 ACBG: Analog Comparator Bandgap Select" on page 151
- 11. Updated "Calibration Byte" on page 162.
- 12. Updated "DC Characteristics" on page 179.
- 13. Updated "Register Summary" on page 9.
- 14. Updated "Ordering Information" on page 13.
- Changed occurences of OCnA to OCFnA, OCnB to OCFnB and OC1x to OCF1x.

Changes from Rev. 2514G-10/04 to Rev. 2514H-02/05

- 1. Updated Table 6 on page 27, Table 15 on page 36, Table 68 on page 162 and Table 80 on page 181.
- Changed CKSEL default value in "Default Clock Source" on page 25 to 8 MHz.
- 3. Updated "Programming the Flash" on page 167, "Programming the EEPROM" on page 169 and "Enter Programming Mode" on page 165.
- 4. Updated "DC Characteristics" on page 179.
- 5. MLF option updated to "Quad Flat No-Lead/Micro Lead Frame (QFN/MLF)"

Changes from Rev. 2514F-08/04 to Rev. 2514G-10/04

- 1. Updated "Features" on page 1.
- 2. Updated "Pinout ATtiny2313" on page 2.
- 3. Updated "Ordering Information" on page 13.
- 4. Updated "Packaging Information" on page 14.
- 5. Updated "Errata" on page 17.

Changes from Rev. 2514E-04/04 to Rev. 2514F-08/04

- 1. Updated "Features" on page 1.
- 2. Updated "Alternate Functions of Port B" on page 55.
- 3. Updated "Calibration Byte" on page 162.
- 4. Moved Table 69 on page 162 and Table 70 on page 162 to "Page Size" on page 162.
- 5. Updated "Enter Programming Mode" on page 165.
- 6. Updated "Serial Programming Algorithm" on page 175.
- 7. Updated Table 78 on page 176.
- 8. Updated "DC Characteristics" on page 179.
- 9. Updated "ATtiny2313 Typical Characteristics" on page 183.
- 10. Changed occurrences of PCINT15 to PCINT7, EEMWE to EEMPE and EEWE to EEPE in the document.

Changes from Rev. 2514D-03/04 to Rev. 2514E-04/04

- 1. Speed Grades changed
 - 12MHz to 10MHz
 - 24MHz to 20MHz
- 2. Updated Figure 1 on page 2.
- 3. Updated "Ordering Information" on page 13.
- 4. Updated "Maximum Speed vs. V_{CC}" on page 182.
- 5. Updated "ATtiny2313 Typical Characteristics" on page 183.

Changes from Rev. 2514C-12/03 to Rev. 2514D-03/04

- 1. Updated Table 2 on page 25.
- 2. Replaced "Watchdog Timer" on page 41.
- 3. Added "Maximum Speed vs. V_{CC}" on page 182.
- 4. "Serial Programming Algorithm" on page 175 updated.
- 5. Changed mA to μA in preliminary Figure 136 on page 209.
- 6. "Ordering Information" on page 13 updated.

MLF package option removed

- 7. Package drawing "20P3" on page 14 updated.
- 8. Updated C-code examples.
- 9. Renamed instances of SPMEN to SELFPRGEN, Self Programming Enable.

Changes from Rev. 2514B-09/03 to Rev. 2514C-12/03

1. Updated "Calibrated Internal RC Oscillator" on page 27.





Changes from Rev. 2514A-09/03 to Rev. 2514B-09/03

- 1. Fixed typo from UART to USART and updated Speed Grades and Power Consumption Estimates in "Features" on page 1.
- 2. Updated "Pin Configurations" on page 2.
- 3. Updated Table 15 on page 36 and Table 80 on page 181.
- 4. Updated item 5 in "Serial Programming Algorithm" on page 175.
- 5. Updated "Electrical Characteristics" on page 179.
- 6. Updated Figure 82 on page 182 and added Figure 83 on page 182.
- 7. Changed SFIOR to GTCCR in "Register Summary" on page 9.
- 8. Updated "Ordering Information" on page 13.
- 9. Added new errata in "Errata" on page 17.





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